**Design Cross Section Chart**

**ALL UNITS ARE IN MILLIMETERS**

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<th>DRILL CHART: TOP to BOTTOM</th>
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**TOTAL THICKNESS**: 1.596 MM

**L1**: TOP CONDUCTOR - COPPER 0.035 MM

**L2**: L2 CONDUCTOR - COPPER 0.018 MM

**L3**: L3 CONDUCTOR - COPPER 0.018 MM

**L4**: BOTTOM CONDUCTOR - COPPER 0.035 MM

**SURFACE - AIR 0 MM**

**DIELECTRIC**: FR-4 0.175 MM

**DIELECTRIC**: FR-4 1.14 MM
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